

## 45V N-Channel Enhancement Mode MOSFET

### 1. Product Information

#### 1.1 Features

- ◇ Surface-mounted package
- ◇ Advanced SGT cell design

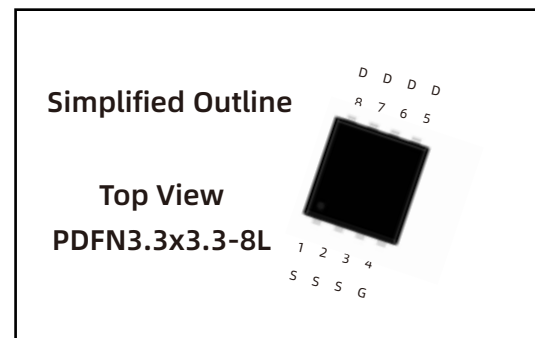
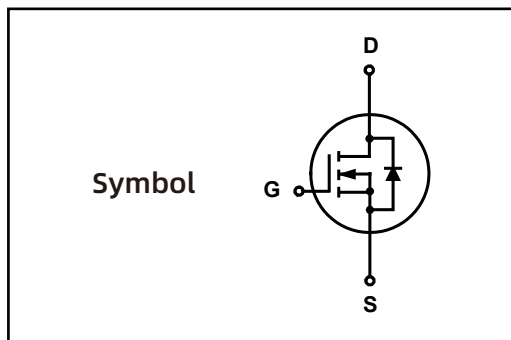
#### 1.2 Applications

- ◇ MB and NB
- ◇ Motor drivers
- ◇ Half - bridge Drivers

#### 1.3 Quick reference

- ◇  $BV \cong 45\text{ V}$
- ◇  $P_{\text{tot}} \cong 28\text{ W}$
- ◇  $I_D \cong 83\text{ A}$
- ◇  $R_{\text{DS(ON)}} \cong 2.0\text{ m}\Omega @ V_{\text{GS}} = 10\text{ V}$
- ◇  $R_{\text{DS(ON)}} \cong 3.0\text{ m}\Omega @ V_{\text{GS}} = 4.5\text{ V}$

### 2. Pin Description



### 3. Marking Information

Product Name	Marking
LN025N045Q	LN025N045Q CYWWZZ XXXXXX

## 4. Limiting Values

Symbol	Parameter	Conditions	Min	Max	Unit
$V_{DS}$	Drain-Source Voltage	$T_C = 25\text{ }^\circ\text{C}$	-	45	V
$V_{GS}$	Gate-Source Voltage	$T_C = 25\text{ }^\circ\text{C}$	-	$\pm 20$	V
$I_D$	Drain Current ( DC )	$T_C = 25\text{ }^\circ\text{C}, V_{GS} = 10\text{ V}$	-	83	A
		$T_C = 100\text{ }^\circ\text{C}, V_{GS} = 10\text{ V}$	-	59	A
$I_{DM}^{**}$	Drain Current ( Pulsed )	$T_C = 25\text{ }^\circ\text{C}, V_{GS} = 10\text{ V}$	-	332	A
$P_{tot}$	Drain power dissipation	$T_C = 25\text{ }^\circ\text{C}$	-	28	W
$T_{stg}$	Storage Temperature		-55	175	$^\circ\text{C}$
$T_J$	Junction Temperature		-	175	$^\circ\text{C}$
$I_S$	Continuous-Source Current	$T_C = 25\text{ }^\circ\text{C}$	-	83	A
$E_{AS}$	Single Pulsed Avalanche Energy	$V_{DD} = 40\text{ V}, L = 1.0\text{mH}$	-	312	mJ
$R_{\theta JA}^*$	Thermal Resistance- Junction to Ambient		-	69	$^\circ\text{C/W}$
$R_{\theta JC}$	Thermal Resistance- Junction to Case		-	5.3	

Notes :

- \* Surface Mounted on 1 in<sup>2</sup> pad area,  $t \leq 10\text{ sec}$
- \*\* Pulse width  $\leq 300\text{ }\mu\text{s}$ , duty cycle  $\leq 2\%$
- \*\*\* limited by bonding wire

## 5. Ordering Code

Product Name	Package	Reel Size	Tape width	Quantity	Note
LN025N045Q	PDFN3.3*3.3			5000	

Note: COMTECH defines " Green " as lead-free ( RoHS compliant ) and halogen free ( Br or Cl does not exceed 900 ppm by weight in homogeneous material and total of Br and Cl does not exceed 1500 ppm by weight; Follow IEC 61249-2-21 and IPC / JEDEC J-STD-020C )

## 6. Electrical Characteristics ( $T_A=25^\circ$ Unless Otherwise Noted )

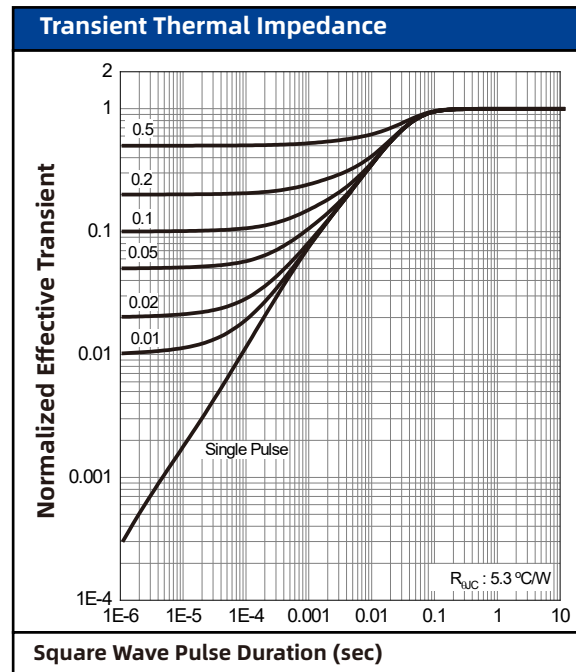
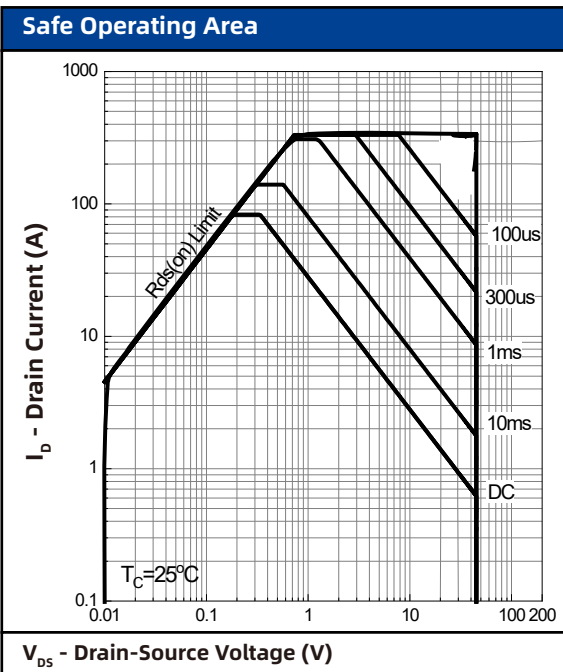
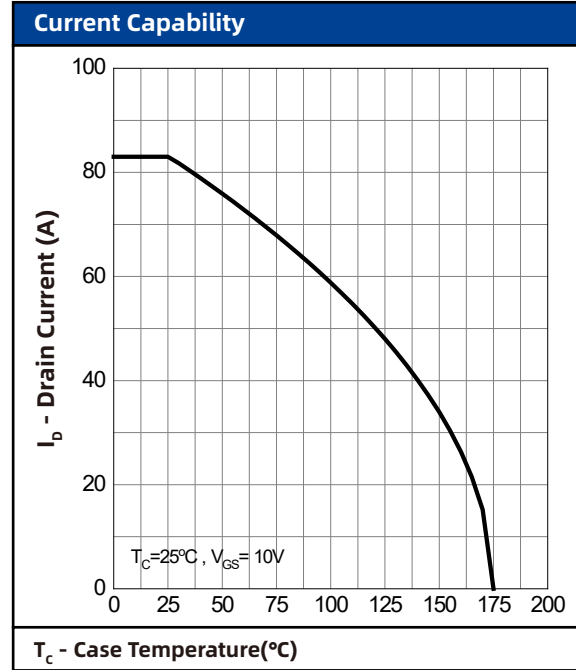
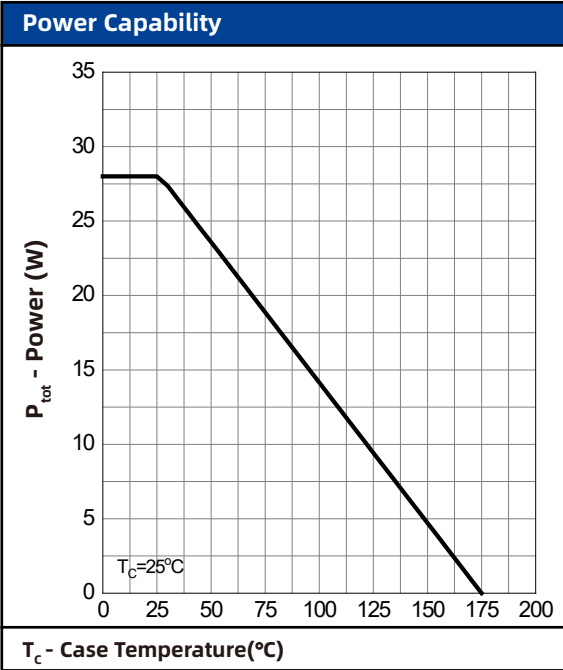
Symbol	Parameter	Conditions	Min	Typ	Max	Unit
<b>Static Characteristics</b>						
$BV_{DSS}$	Drain-Source Breakdown Voltage	$V_{GS} = 0\text{ V}, I_{DS} = 250\ \mu\text{A}$	45	-	-	V
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{DS} = 250\ \mu\text{A}$	1.0	-	2.0	V
$I_{DSS}$	Drain Leakage Current	$V_{DS} = 36\text{ V}, V_{GS} = 0\text{ V}$	-	-	1	$\mu\text{A}$
$I_{GSS}$	Gate Leakage Current	$V_{DS} = 0\text{ V}, V_{GS} = \pm 20\text{ V}$	-	-	$\pm 100$	nA
$R_{DS(on)}^a$	On-State Resistance	$V_{GS} = 10\text{ V}, I_{DS} = 20\text{ A}$	-	1.8	2.0	m $\Omega$
		$V_{GS} = 4.5\text{ V}, I_{DS} = 10\text{ A}$	-	2.7	3.0	
<b>Diode Characteristics</b>						
$V_{SD}^a$	Diode Forward Voltage	$I_{SD} = 20\text{ A}, V_{GS} = 0\text{ V}$	-	-	1.3	V
$t_{rr}$	Reverse Recovery Time	$I_{DS} = 20\text{ A}$	-	39	-	nS
$Q_{rr}$	Reverse Recovery Charge	$dI_{SD}/dt = 100\text{ A}/\mu\text{s}$	-	25	-	nC
<b>Dynamic Characteristics<sup>b</sup></b>						
$C_{ISS}$	Input Capacitance	$V_{GS} = 0\text{ V}, V_{DS} = 20\text{ V}$	-	2403	-	pF
$C_{OSS}$	Output Capacitance	Frequency = 1 MHz	-	802	-	
$C_{rSS}$	Reverse Transfer Capacitance		-	62	-	
$t_d(on)$	Turn-on Delay Time	$V_{DS} = 20\text{ V}, V_{GEN} = 10\text{ V},$ $R_G = 3.9\ \Omega, R_L = 1\ \Omega,$ $I_{DS} = 20\text{ A}$	-	9	-	nS
$t_r$	Turn-on Rise Time		-	45	-	
$t_d(off)$	Turn-off Delay Time		-	43	-	
$t_f$	Turn-off Fall Time		-	28	-	
<b>Gate Charge Characteristics<sup>b</sup></b>						
$Q_g$	Total Gate Charge	$V_{DS} = 20\text{ V}, V_{GS} = 10\text{ V},$ $I_{DS} = 20\text{ A}$	-	46	-	nC
$Q_{gs}$	Gate-Source Charge		-	10	-	
$Q_{gd}$	Gate-Drain Charge		-	9	-	

Notes :

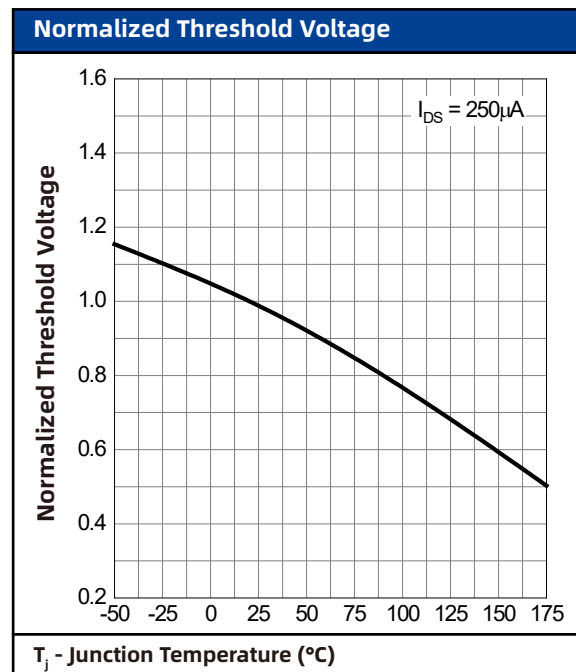
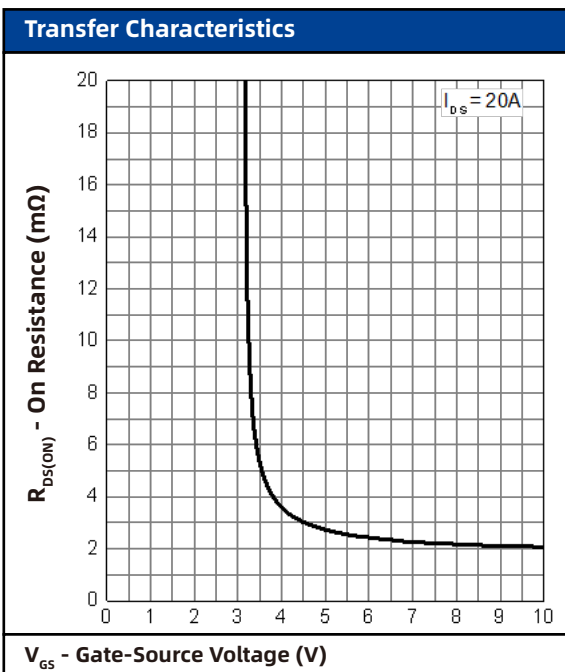
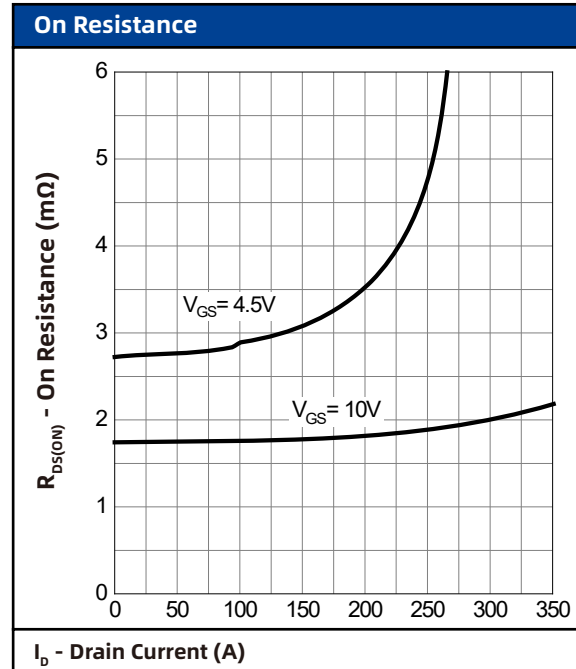
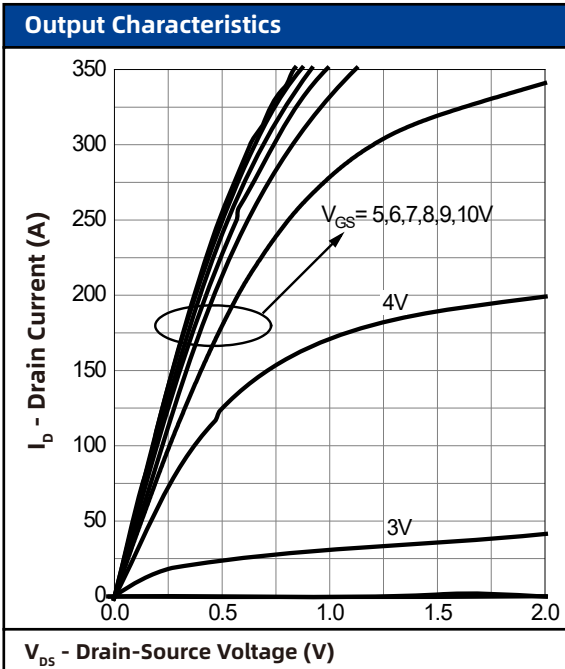
a : Pulse test ; pulse width  $\leq 300\ \mu\text{s}$ , duty cycle  $\leq 2\%$

b : Guaranteed by design, not subject to production testing

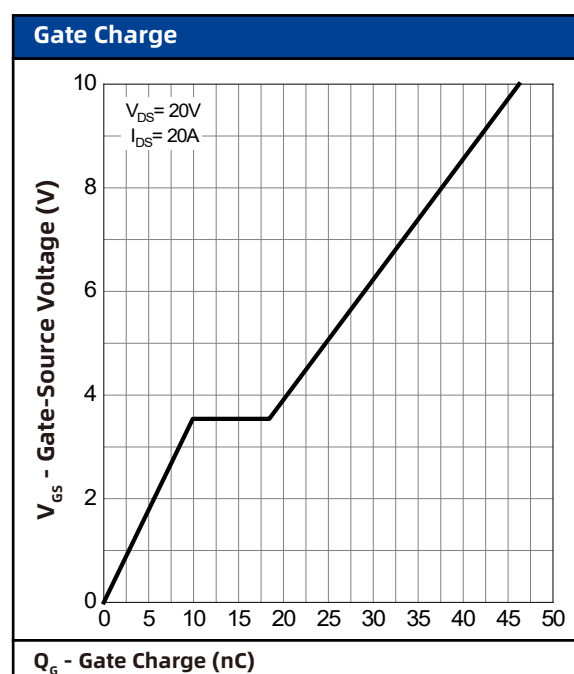
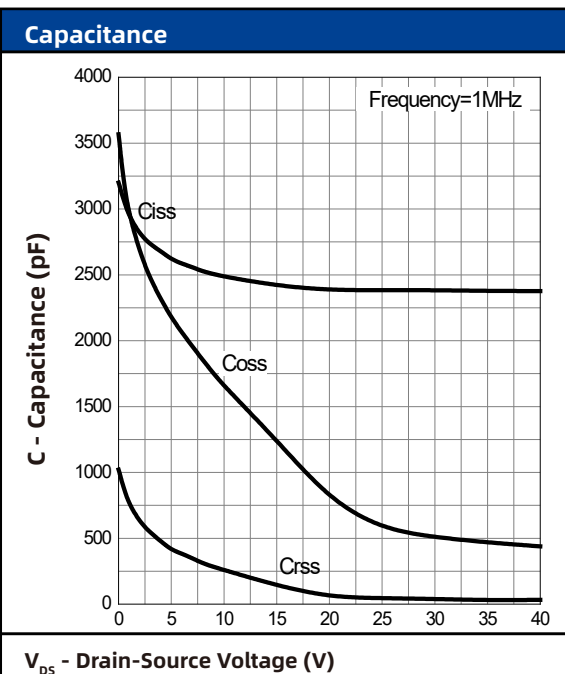
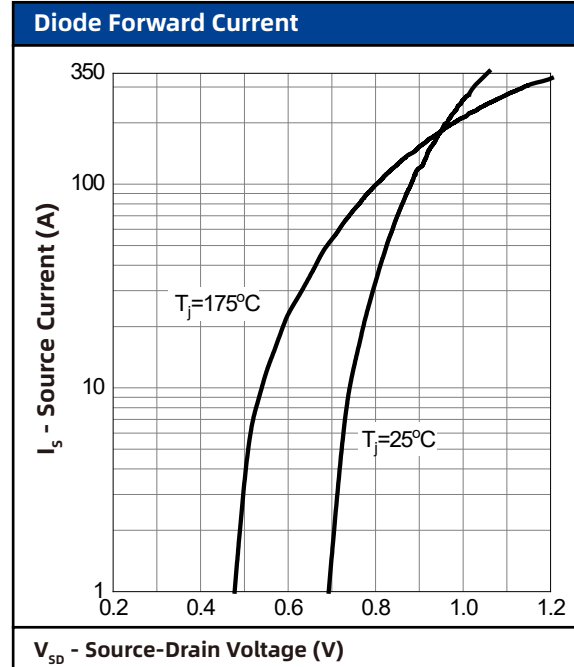
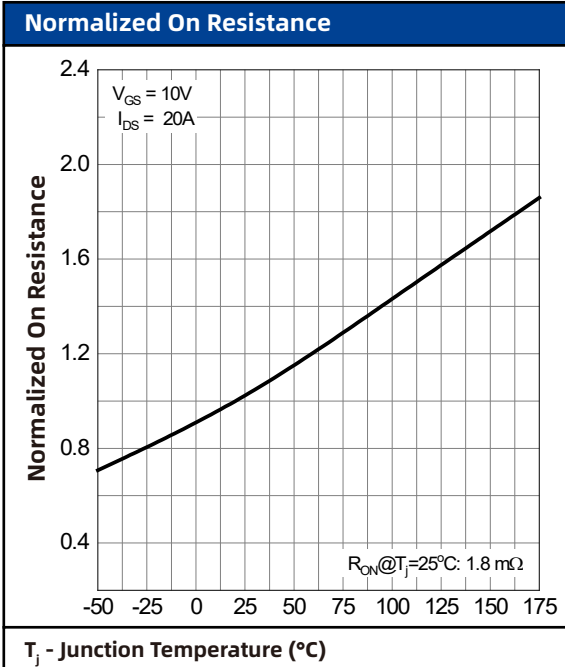
## 7. Typical Characteristics



## 7. Typical Characteristics (cont.)

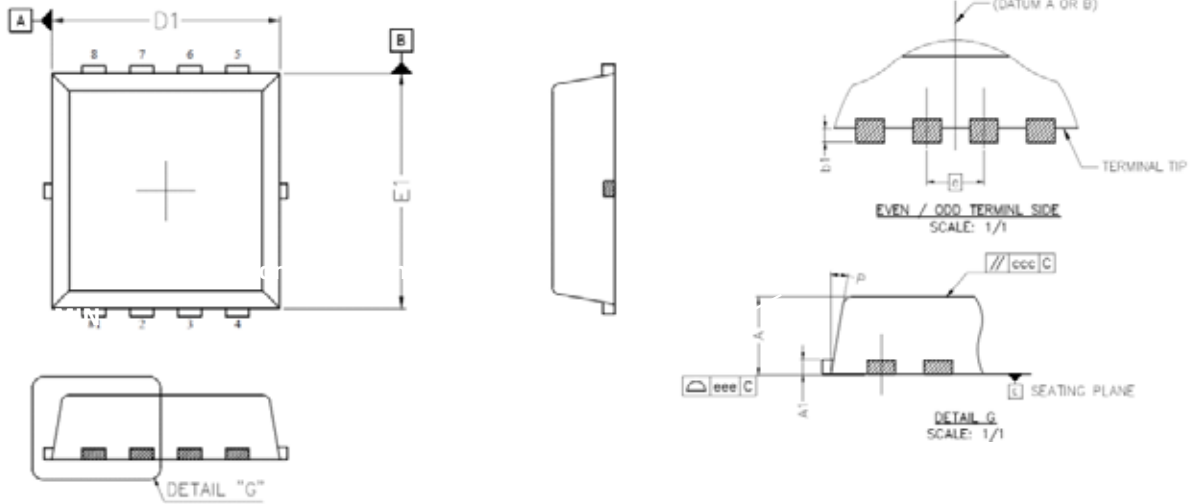


## 7. Typical Characteristics (cont.)



## 8. Package Dimensions

### PDFN3.3\*3.3-8L Package



Symbol	Dimensions In Millimeters	
	MIN.	MAX.
A	0.80	0.90
A1	0.12	0.22
b	0.27	0.37
b1	0.05	0.15
D	3.00	3.60
D1	3.00	3.20
D2	2.29	2.69
E	3.00	3.60
E1	3.00	3.20
E2	2.00	2.20
e	0.60	0.70
j	0.15	0.35
k	0.60	0.80
n	0.15	0.35
M	0.20	
P	9°	11°
z	0.58	
ccc	0.10	
ddd	0.05	
eee	0.05	